

打鍵部推奨条件 Push part recommended conditions

REFERENCE

DRAWN

岩 波

09.02.20

CHECKED

APPROVED

山本

10.04.21

SCALE

15

DESIGNED

山 形

※基板パターンにてB−D間を繋いでください。 To be connected B and D by PCB pattern.

- ランド指定領域 Appointed area of soldering
- ランドパターン禁止領域 Prohibition area of exposing patterns

プリント基板ランド推奨寸法 PCB land recommended dimensions

	7	カパーテープ	COVER TAPE		
	6	キャリアテープ	CARRIER TAPE		
	15	カパー	COVER	1	PBSR Sn plated
	4	ダストカパー	DUST COVER	1	PI
	ო	コンタクトブレード	CONTACT BLADE	1	SUS Ag plated
	2	端子	TERMINAL	1	PBSR Ag plated
	1	ペースモールド	BASE MOLD	1	LCP
	No.	PART NAME		QTY	REMARKS
					THIRD AND E DOO ECTION UNIT

Note 3. Operating force : 1st <0.3N 2nd 1.5±0.5N

Note 2. Taping specification : spec No. TSW-24T-1

Note 1. Product specification : spec No. TSW-24

回路 CIRCUIT

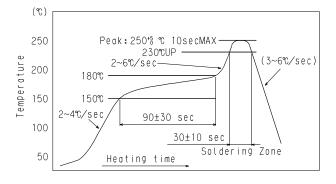
Spec No. TSW-24-01BJ-T80.1/3 SPECIFICATION FOR TACTILE SWITCH 16.03.10 S. Yamagata 1. Structure : 1-circuit 2-contact point push-on switch (normal open) of double action 2. Maximum rating : 12V DC 50mA (Resistance load) : 1-circuit 2-contact point 3. Circuit 4. Operation temperature : -20° C to $+70^{\circ}$ C Range 5. Storage temperature : -30° C to $+80^{\circ}$ C (except carrier tape) Range 6. Mechanical performance Item Specification Test conditions Operation force Refer to product drawing. Placing the switch such that the operating direction is vertical. The load is added to the center of operation area, and the peak load is measured. Travel Refer to product drawing. Placing the switch such that the operating direction is vertical. The position from the printed circuit board to the ON position is measured in the center of operation area. Stop strength Table 9 criteria shall be Placing the switch such that the operating direction is satisfied. vertical. The static load of 29N (3kgf) is added in the center operation area for 5 seconds. (1) More than 75 % of Flux shall be methanol (JIS K 1501) solution of Resistance to flux and the dipped part shall Rosin (JIS K 5902), density of rosin approx. 25 wt%. soldering be covered with (Unless any doubt NA200 [Tamura Chemical] or equivalent.) solder. Fluxed terminal shall be dipped into a soldering bath (2) Table 9 criteria shall $(230\pm5$ °C) for 3 ± 0.5 seconds. be satisfied. Table 9 criteria shall be (1) Reflow soldering: Resistance to soldering heat. satisfied. Measurement shall be made in normal room temperature after But, In externals and the leaving the switch in a thermostatic chamber at 150 ± 2 °C for structure, no do striking 3 minutes followed by leaving it in a chamber at 250 ± 2 °C changes. for 1 minute. Reflow shall be one time. (2) Manual soldering : Power of soldering iron: 15 W Diameter of soldering iron tip: 1 mm Temperature of soldering iron tip: 320±5 ℃ Soldering time: 3 seconds max. The terminal shall be free from abnormal pressure when the soldering iron is applied to the tip of terminal. 7. Electrical performance Test conditions Item Specification Contact 100 m Ω max. After the switch is operated several times by without load. resistance it is measured by Low ohmmeter (measuring frequency 1kHz , voltage and current : 20mV, 50mA or less), when the static load of the twice operation force is added to center of operation area. Insulation 100 M Ω min. It is measured by megohmmeter (measured voltage : 500VDC) resistance between each terminal, and between each terminal and frame. Withstanding No insulation The voltage of 100VAC is impressed for 1 minute between each Destruction at 100VAC voltage terminal, and between each terminal and frame. Measured at DC 5V, 1mA, operation speed of 60rpm. 10ms or less Chattering Chattering is assumed to be a voltage change of 1.5V or more.

Spec No. TSW-24-01BJ-T80. 2/3 SPECIFICATION FOR TACTILE SWITCH 16.03.10 S. Yamagata 8. Life Test and Special Test. Item Method of Test and Testing conditions Specification Durability (1) Without load Table 9 criteria (2) Rate of operation: 15 to 20 operations per minute shall be (3) Push force: push force of the standard max value satisfied. (4) Cycle of operation: 100,000 cycles Resistibility to Measured within 1 hour after keeping the switch in the chamber at Ditto Heat 85 ± 2 °C for 96 hours then leaving it in the normal temperature and humidity for 1 hour. Resistibility to Measured within 1 hour after keeping the switch in the chamber at Ditto Humidity 40 ± 2 °C, 90-95%RH 96 hours then leaving it in the normal temperature and humidity for 1 hour. Here, water drops shall be removed. Measured within 1 hour after keeping the switch in the chamber at Resistibility to Ditto Cold -30 ± 2 °C for 96 hours then leaving it in the normal temperature and humidity for 1 hour. Here, water drops shall be removed. Resistibility to Measurements shall be made following the test set forth below: Ditto Vibration (1) Vibration frequency range : 10 to 55 Hz (2) Cycle of sweep: $10 \sim 55 \sim 10$ Hz in 1 minute (3) Total amplitude, pk-to-pk : 1.5 mm (4) Sweep ratio: Logarithmical sweep or uniform sweep (5) Direction of oscillation: Three mutually perpendicular directions, including the direction of stem travel. (6) Duration: 2 hours each, total 6 hours. Criteria of Life Test and Special Test. Item Criteria Within $\pm 30\%$ of the initial value Operation Force Contact Resistance 1000 m Ω max Insulation Resistance 10 M Ω min 4 Withstanding Voltage NO abnormal for 1 minute at 100VAC. 5 Chattering 20ms or less Others No abnormal in externals and the structure.

SPECIFICATION FOR TACTILE SWITCH

11. Precautions :

- (1) The setting of reflow condition should be verified under the actual mass production conditions.
- (2) Characteristics may change due to the warping of printed circuit board. Consideration should be given to the pattern design and layout.
- (3) Please do not wash this switch, for no washing type.
- (4) This switch permits reflow soldering and the switch has the possibility to be mounted on the edge of the printed circuit board. But auto-dip shall not be done after the mounting of the switch because of the big possibility of the penetration of the soldering flux into the contacts sliding portion.
- (5) In manual soldering, consider that the abnormal pressure of the soldering iron shall not be applied to the tip of the terminal as well do not apply any pressure for more than 1 minute after soldering.
- (6) Care shall be taken so that the flux shall not penetrate into the terminal portion.
- (7) The operating characteristic will change if force is applied to the top of cover.
- (8) On designing of hardware and software, please consider of chattering.
- (9) Please check the mounting of the switch before using it.
- (10) Example of reflow (reference)
 - ①Heating: Heated from above and below by far-infrared heating.
 - ②Temperature measuring method: Temperature shall be measured by using a 0.1 mm-dia. to 0.2 mm-dia.CA (K) or CC (T) thermocouple at the soldered joint. Heat resisting tape is used to fix the thermocouple.
 - 3 Temperature profile

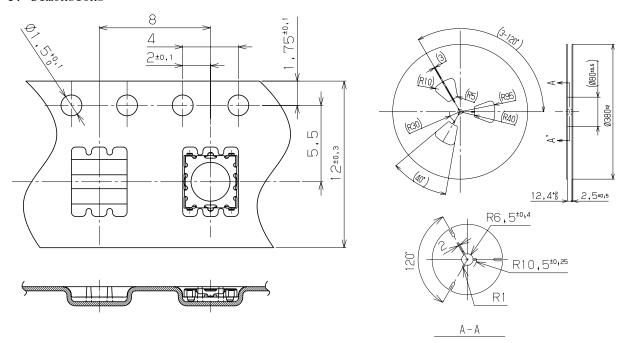


April/10/09	Specification Toning Deckage	SPEC No
T. Iwanami	Specification Taping Package	TSW-24-01BJ-T80

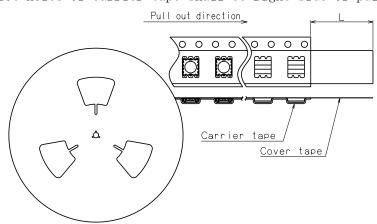
- 1. Scope: This specifications is applied to the taping package for our Tactile switch (model TSW-24 with boss type)
- 2. Parts and materials:

Package specification	Parts	Materials
	Reel	Corrugated cardboard
Taping	Carrier Tape	PET or PS
	Cover Tape	PET or PS

- 3. Package quantity: 8,000pcs. / reel (Standard Quantity)
- 4. Dimensions



- 5. Taping package form:
 - (1) Pilot holes of carrier tape shall be right side of pull out direction.



- (2) Switch lacking and reverse direction packing is max 0.1% of package quantity. It is not continue more than 2 switches.
- (3) Top and end of tape shall be non-packed portion(10 \sim 50 branks) L Dimensions shall be 150mm min.
- (4) Direction of product: Knob shall be opposite side of pull out direction. Switch cover shall be same side of cover tape.
- (5) Peeling strength of cover tape shall be $0.1 \sim 1.0 \text{ N}(10 \sim 100 \text{gf})$
- (6) Following items shall be marked on the reel.
 Our model No, Quantity, Production lot No, Our company name, RoHS mark.